The product information in this catalog is for reference only. Please request the Engineering Drawing for the most current and accurate design information. All non-RoHS produces have been discontinued, or will be discontinued soon. Please check the products status on the Hirose website RoHS search at www.hirose-connectors.com, or contact your Hirose sales representative.

0.5 mm Pitch, 1.0 mm above the board Top Contact, Back-Flip actuator Flexible Printed Circuit & Flexible Flat Cable ZIF Connectors

FH34(S)Series



Features

1. Low-profile

With the 1.0 mm above the board and width of 3.8 mm the connectors are used in space saving applications.

2. Increased FPC/FFC retention

As compared with existing similar construction connectors: * In horizontal direction: Approximately 2.6 times * In vertical direction: Approximately 2 times

3. Unique Back-Flip rotating actuator

The rotating actuator opens from the back of the connector, assuring reliable electrical and mechanical connection.

Easy FPC/ FFC insertion
 Entry chamfers at all sides of the FPC/FFC insertion slot assure correct insertion and positioning of the FPC/FFC.

5. Delivered with the actuator open FPC/FPC can be immediately inserted without the need for the

opening of the actuator.

6. Standard FPC/FFC thickness

Reliable connection with the use of ready available 0.3 mm thick $\ensuremath{\mathsf{FFC}}\xspace/\ensuremath{\mathsf{FPC}}\xspace$

7. Compatible with existing connectors.

FPC/FFC and PCB mounting patterns are the same as for the FH19SC Series (bottom contact), allowing the use of both connectors for interconnections between two boards or replacement of the connectors.

8. Conductive traces on the PCB can run under the connector

No exposed contacts on the bottom of the connector.

9. Board placement with automatic equipment

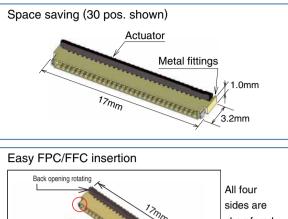
Flat top surface and packaging on the tape-and-reel allows use of vacuum nozzles.

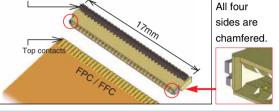
Standard reel contains 5,000 pieces.

Applications

Mobile phones, PDA's, digital cameras, digital camcorders, camera modules and other compact devices requiring Flexible Printed Circuit connections using high reliability extremely small profile connectors.

Increased FPC/FFC holding force





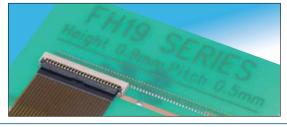
Ready to insert FPC/FFC



FPC/FFC inserted and retained. Completed electrical and mechanical connection.



Compatible with existing connectors.(FH19SC SERIES)



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Specifications

Detinge	Current rating 0.5 A	Operating temperature range: -55 to +85°C (Note 1)	Storage temperature range: -10 to +50°C (Note 2)
Ratings	Voltage rating 50 Vrms AC	Operating humidity range: Relative humidity 90% max. (No condensation)	Storage humidity range: Relative humidity 90% max. (No condensation)

Recommended FPC/FFC Thickness: 0.3 +/- 0.03 mm, Gold plated contact pads

Item	Specification	Conditions
1. Insulation resistance	500 MΩ min.	100 V DC
2. Withstanding voltage	No flashover or insulation breakdown	250 Vrms AC / one minute
3. Contact resistance	100 m Ω max. * Including FPC and FFC conductor resistance	1 mA, AC / DC 20mV max (AC: 1kHz)
4. Durability	Contact resistance: 100 mΩ max. No damage, cracks, or parts dislocation	20 cycles
5. Vibration	No electrical discontinuity of 1μ s or longer Contact resistance: 100 m Ω max. No damage, cracks, or parts dislocation	Frequency: 10 to 55 Hz, single amplitude of 0.75 mm, 10 cycles in each of the 3 axis
6. Shock	No electrical discontinuity of 1μ s or longer Contact resistance: 100 m Ω max. No damage, cracks, or parts dislocation	Acceleration of 981m/s ² , 6 ms duration, sine half- wave, 3 cycles in each of the 3 axis
7. Humidity (Steady state)	Contact resistance: 100 mΩ max. Insulation resistance: 50 MΩ min. No damage, cracks, or parts dislocation	96 hours at 40°C and humidity of 90 to 95%
8. Temperature cycle	Contact resistance: $100 \text{ m}\Omega$ max. Insulation resistance: $50 \text{ M}\Omega$ min. No damage, cracks, or parts dislocation	$\begin{array}{ccc} \text{Temperature} & : -55^{\circ}\text{C} \rightarrow +15^{\circ}\text{C} \text{ to } +35^{\circ}\text{C} \rightarrow +85^{\circ}\text{C} \rightarrow +15^{\circ}\text{C} \text{ to } +35^{\circ}\text{C} \\ \text{Time:} & 30 \rightarrow 2 \text{ to } 3 \rightarrow 30 \rightarrow 2 \text{ to } 3 \text{ minutes} \\ \text{5 cycles} \end{array}$
9. Resistance to soldering heat	No deformation of components affecting performance	Reflow: At the recommended temperature profile Manual soldering: $350^{\circ}C \pm 5^{\circ}C$ for 5 seconds (Note 3)

Note1: Includes temperature rise caused by current flow.

Note2: The term "storage" refers to products stored for a long period prior to mounting and use.

The operating temperature and humidity range covers the non-conducting condition of installed connectors in storage, shipment or during transportation after board mounting.

Note3: Small blisters of the molding compounds in small areas will not affect form, fit or function.

Note4: Information contained in this catalog represents general requirements for this Series.

Contact us for the drawings and specifications for a specific part number shown.

Materials

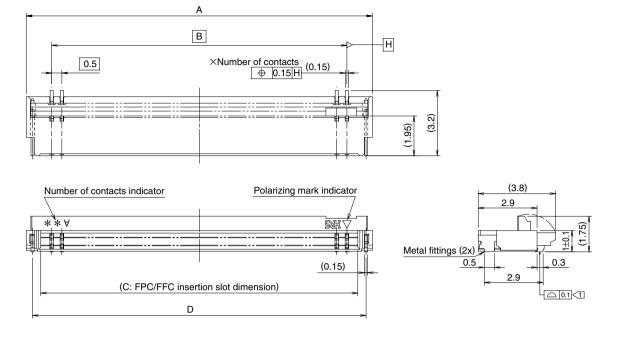
Part	Material	Finish	Remarks
Insulator	LCP	Color: Beige	UL94V-0
Actuator	PA	Color: Black	01940-0
Contacts	Phosphor bronze	Gold plating	
Metal fittings	Phosphor bronze	Pure tin reflow plating	

Ordering information

	FH34	S -	30S	- 0.5	SH	(50)	
	1	2	3	4	6	6	
 Series name 	: FH34		6	Termination	type :		
2 S	: FPC/FFC 0.3 m	m thick		SH	: SM	T horizontal mo	ounting type
3 Number of positi	ons : 4, 8, 11, 14, 16, 2	2 26, 30, 3	2, 34 🌀	Plating speci	fications	(50)Gold plat	ting with nickel barrie
4 Contact pitch	: 0.5mm					5,000 pie	eces / reel

The product information in this catalog is for reference only. Please request the Engineering Drawing for the most current and accurate design information. All non-RoHS products have best (5) stimles on the precipited on the association of the board of

Connector Dimensions



Note $\boxed{1}$: The coplanarity of each terminal lead is within 0.1.

Note 2 : Slight variations in color of the plastic compounds do not affect form ,fit or function of the connector.

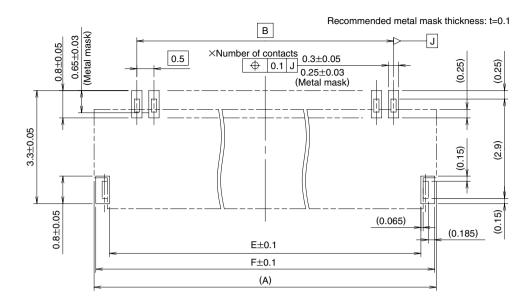
						All dime	nsions: mm
Part Number	CL No.	Number of Contacts	А	В	С	D	RoHS
FH34S- 4S-0.5SH(50)	580-1203-2-50	4	4	1.5	2.53	3.38	
FH34S- 6S-0.5SH(50)	Reserved for product expansion	6	5	2.5	3.53	4.38	
FH34S- 8S-0.5SH(50)	580-1204-5-50	8	6	3.5	4.53	5.38	
FH34S- 9S-0.5SH(50)	Reserved for product expansion	9	6.5	4	5.03	5.88	
FH34S-11S-0.5SH(50)	580-1213-6-50	11	7.5	5	6.03	6.88	
FH34S-12S-0.5SH(50)	Reserved for product expansion	12	8	5.5	6.53	7.38	
FH34S-14S-0.5SH(50)	580-1206-0-50	14	9	6.5	7.53	8.38	
FH34S-16S-0.5SH(50)	580-1211-0-50	16	10	7.5	8.57	9.38	YES
FH34S-20S-0.5SH(50)	Reserved for product expansion	20	12	9.5	10.57	11.38	
FH34S-22S-0.5SH(50)	580-1216-4-50	22	13	10.5	11.57	12.38	
FH34S-24S-0.5SH(50)	Reserved for product expansion	24	14	11.5	12.57	13.38	
FH34S-26S-0.5SH(50)	580-1212-3-50	26	15	12.5	13.57	14.38	
FH34S-28S-0.5SH(50)	Reserved for product expansion	28	16	13.5	14.57	15.38	
FH34S-30S-0.5SH(50)	580-1201-7-50	30	17	14.5	15.57	16.38	
FH34S-32S-0.5SH(50)	580-1208-6-50	32	18	15.5	16.57	17.38	
FH34S-34S-0.5SH(50)	580-1207-3-50	34	19	16.5	17.57	18.38	

Tape and reel packaging (5,000 pieces/reel).

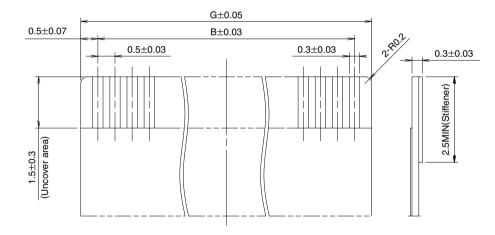
Order by number of reels.

The product information in this catalog is for reference only. Please request the Engineering Drawing for the most current and accurate design information. All non-Rolfs products Star less for minutations in the discrete book of the book of the book of the book of the

Recommended PCB mounting pattern and metal mask dimensions



Recommended FPC/FFC Dimensions

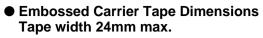


*Polyimide and thermally hardening adhesive is recommended as the materials for the stiffener. Note: When using the FPC/FFC in FH34S or FH19SC connectors, the exposed area inserted in either connector is 2.5mm ± 0.3mm and the stiffener is 3.5mm min.

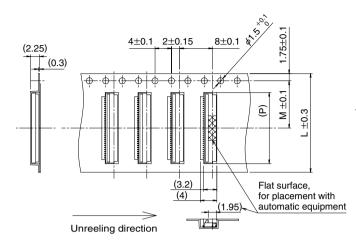
						All dime	nsions: mm
Part Number	CL No.	Number of Contacts	А	В	E	F	G
FH34S- 4S-0.5SH(50)	580-1203-2-50	4	4.0	1.5	3.1	3.9	2.5
FH34S- 6S-0.5SH(50)	Reserved for product expansion	6	5.0	2.5	4.1	4.9	3.5
FH34S- 8S-0.5SH(50)	580-1204-5-50	8	6.0	3.5	5.1	5.9	4.5
FH34S- 9S-0.5SH(50)	Reserved for product expansion	9	6.5	4.0	5.6	6.4	5.0
FH34S-11S-0.5SH(50)	580-1213-6-50	11	7.5	5.0	6.6	7.4	6.0
FH34S-12S-0.5SH(50)	Reserved for product expansion	12	8.0	5.5	7.1	7.9	6.5
FH34S-14S-0.5SH(50)	580-1206-0-50	14	9.0	6.5	8.1	8.9	7.5
FH34S-16S-0.5SH(50)	580-1211-0-50	16	10.0	7.5	9.1	9.9	8.5
FH34S-20S-0.5SH(50)	Reserved for product expansion	20	12.0	9.5	11.1	11.9	10.5
FH34S-22S-0.5SH(50)	580-1216-4-50	22	13.0	10.5	12.1	12.9	11.5
FH34S-24S-0.5SH(50)	Reserved for product expansion	24	14.0	11.5	13.1	13.9	12.5
FH34S-26S-0.5SH(50)	580-1212-3-50	26	15.0	12.5	14.1	14.9	13.5
FH34S-28S-0.5SH(50)	Reserved for product expansion	28	16.0	13.5	15.1	15.9	14.5
FH34S-30S-0.5SH(50)	580-1201-7-50	30	17.0	14.5	16.1	16.9	15.5
FH34S-32S-0.5SH(50)	580-1208-6-50	32	18.0	15.5	17.1	17.9	16.5
FH34S-34S-0.5SH(50)	580-1207-3-50	34	19.0	16.5	18.1	18.9	17.5

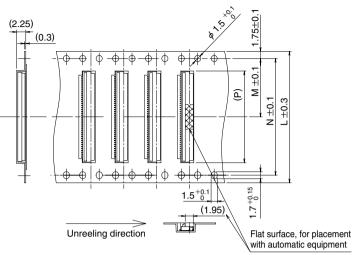
The product information in this catalog is for reference only. Please request the Engineering Drawing for the most current and accurate design information. All non-RoHS products have head (3) Stimules with the first the design of the board of the board

► Packaging Specification

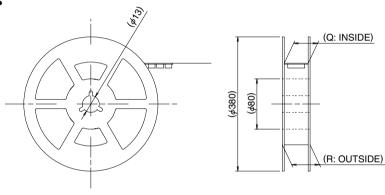


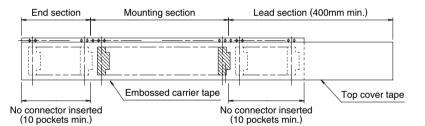
• Embossed Carrier Tape Dimensions Tape width of 32mm min.





Reel Dimensions





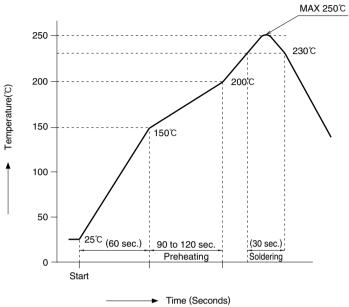
			.,			A	All dimens	ions: mm
Part Number	CL No.	Number of Contacts	L	М	N	Р	Q	R
FH34S- 4S-0.5SH(50)	580-1203-2-50	4	16	7.5	_	4.3	17.4	21.4
FH34S- 6S-0.5SH(50)	Reserved for product expansion	6	16	7.5	—	5.3	17.4	21.4
FH34S- 8S-0.5SH(50)	580-1204-5-50	8	16	7.5	—	6.3	17.4	21.4
FH34S- 9S-0.5SH(50)	Reserved for product expansion	9	16	7.5	—	6.8	17.4	21.4
FH34S-11S-0.5SH(50)	580-1213-6-50	11	16	7.5	—	7.8	17.4	21.4
FH34S-12S-0.5SH(50)	Reserved for product expansion	12	24	11.5	—	8.3	25.4	29.4
FH34S-14S-0.5SH(50)	580-1206-0-50	14	24	11.5	—	9.3	25.4	29.4
FH34S-16S-0.5SH(50)	580-1211-0-50	16	24	11.5	—	10.3	25.4	29.4
FH34S-20S-0.5SH(50)	Reserved for product expansion	20	24	11.5	—	12.3	25.4	29.4
FH34S-22S-0.5SH(50)	580-1216-4-50	22	24	11.5	—	13.3	25.4	29.4
FH34S-24S-0.5SH(50)	Reserved for product expansion	24	24	11.5	—	14.3	25.4	29.4
FH34S-26S-0.5SH(50)	580-1212-3-50	26	24	11.5	—	15.3	25.4	29.4
FH34S-28S-0.5SH(50)	Reserved for product expansion	28	32	14.2	28.4	16.3	33.4	37.4
FH34S-30S-0.5SH(50)	580-1201-7-50	30	32	14.2	28.4	17.3	33.4	37.4
FH34S-32S-0.5SH(50)	580-1208-6-50	32	32	14.2	28.4	18.3	33.4	37.4
FH34S-34S-0.5SH(50)	580-1207-3-50	34	32	14.2	28.4	19.3	33.4	37.4

Tape and reel packaging (5,000 pieces/reel).

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Temperature Profile

• Using Lead-free Solder Paste



DC HRS test condition

Solder method	:	Reflow, IR/hot air (Nihon Den-netsu Co., Ltd.'s Part Number:SENSBY NR-2)
Environment	:	Room air
Solder composition	:	Paste, 96.5%Sn/3.0%Ag/0.5%Cu
		(Senju Metal Industry, Co., Ltd.'s Part Number:
		M705-221CM5-42-10.5)
Test board	:	Glass epoxy 25mm \times 40mm \times 0.8mm thick
Land dimensions	:	0.3mm×0.8mm
Metal mask	:	0.25×0.65×0.1mm thick

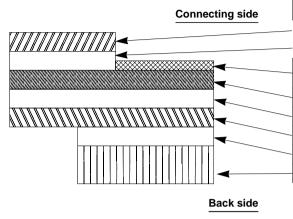
The temperature profiles shown are based on the above conditions. In individual applications the actual temperature may vary, depending on solder paste type, volume / thickness and board size / thickness. Consult your solder paste and equipment manufacturer for specific recommendations. The product information in this catalog is for reference only. Please request the Engineering Drawing for the most current and accurate design information. All non-RoHS products have here here to so with the here the second of the content of the second of the

Recommended FPC construction

• Contact FPC manufacturer for specific details.

1. Using Single-sided FPC

FPC : Flexible Printed Circuit



Material Name	Material	Material Thickness (µm)
Covering film layer	Polyimide 1 mil thick	25
Cover adhesive		25
Surface treatment	$0.2\mu m$ thick gold plated over 1 to $5\mu m$ thick nickel underplating	3
Copper foil	Cu 1oz	35
Base adhesive		25
Base film	Polyimide 1 mil thick	25
Reinforcement material adhesive	Thermosetting adhesive	35
Stiffener	Polyimide 7 mil thick	175
	Total	298

2. Using Double-sided FPC FPC : Flexible Printed Circuit

Connecting side	Material Name	Material	Material Thickness (µm)
	 Covering layer film 	Polyimide 1 mil thick	
	 Cover adhesive 		
	Surface treatment	$0.2\mu m$ thick gold plated over 1 to $5\mu m$ thick nickel underplating	3
())))))))))))))))))))))))))))))))))))	Through-hole copper	Cu	15
	Copper foil	Cu 1/2oz	18
	Base adhesive		18
	Base film	Polyimide 1 mil thick	25
	Base adhesive		18
	Copper foil	Cu 1/2oz	18
	Cover adhesive		25
	Covering film layer	Polyimide 1 mil thick	25
	Reinforcement material adhesive	Thermosetting adhesive	50
Back side	Stiffener	Polyimide 4 mil thick	100
		Total	297

* To prevent release of the FPC due to its bending, use of the double sided FPC with copper foil on the back side is NOT RECOMMENDED.



FFC : Flexible Flat Cable

Connecting side	Material Name	Material	Material Thickness (µm)
////////////////	Polyester film		12
	— Adhesive	Thermoplastic polyester	30
	Gold plated annealed copper foil		35
	Adhesive	Polyester	30
	Polyester		12
	Adhesive	Polyester	30
	Stiffener	Polyester	188
		Total	295

Back side

Note: Recommended FPC/FFC thickness: 0.3 \pm 0.03 mm

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Operation and Precautions

Exercise care when handling connectors. Follow recommendations given below

Operation	Precautions
1. As delivered Delivered with the actuator opera. There is no need to operate the actuator prior to inserting the FPC/FFC.	• Do not close the actuator without the FPC/FPC inserted.
2. FPC/FFC insertion Insert the FPC/FFC with the conductive surfaces facing up. Align the FPC/FFC straight with the connector and insert it firmly all the way.	 This connector is of the top contact specification. The contacts are making connection with the FPC/FFC pads from the top. Do not insert the FPC/FFC with the pads facing down. When inserting the FPC/FFC do not twist it. Insert straight. Improper insertion may cause deformation of the contacts and connection failures. Be sure to insert the FPC/FFC when the actuator is fully open.
	 Do not operate the actuator by only one end. Open or close by pushing at the center. Do not try to rotate the actuator past the fully open 90° position. This will damage the connector, preventing it from use. Do not apply excessive force to the connector when the actuator is closed.
4. FPC/FFC removal (Lock release) Carefully rotate the actuator up to 90°, lifting it at the center.	 Do not operate the actuator from one end only. The actuator opens only 90°. Do not attempt to open it past this angle or grasp it.
	 During the opening of the actuator do not press it toward the connector body. Rotate up at the center.

8 **HS**

Lift at the center

Raise

Precautions at the Design Stage

- (1) Route the FPC/FFC so that a direct pull force
- (2) Make sure that there is enough space to insert/remove the FPC/FFC straight.
- (3) Follow the recommendations given in this catalog in regard to mounting pattern, metal mask dimensions and FPC/FFC mating dimensions.
- (4) Consult the manufacturer of the FPC/FFC for the details on the flexibility of the specific FPC/FFC.
- (5) When designing the board lay-out and spaces in the device assure that there is enough clearances for the actuator to fully open/close.

Precautions when mounting connectors on the PCB

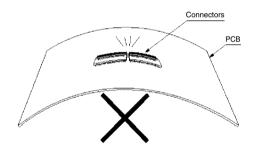
\blacklozenge Handling before mounting on PCB

Insertion of the FPC/FFC or operation of the actuator prior to mounting on the PCB is NOT RECOMMENDED.

◆PC board warpage

Minimize the warpage as much as possible. The connector are straight within 0.1 mm max. Make sure that the mounting area flatness can accept the connector terminals without causing any failure of the solder joints.

- ♦Forces on the board
- When braking the large PC board into individual boards exercise care NOT to damage the installed connectors.
- When attaching the boards or other components with the screws make sure that any stresses will NOT cause board deflections affecting the mounting areas of the connector.



When hand soldering:

 \cdot Do not perform hand soldering with the FPC inserted in the connector.

* Do not apply excessive heat or touch the soldering iron anywhere other than the connector leads.

* Do not use excessive amount of solder or flux compounds.

Operation of the actuator or contacts may be affected by excessive amounts of solder or flux compounds.